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Vishay Siliconix

N-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY						
V _{DS} (V)	30					
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.00683					
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.01050					
Q _g typ. (nC)	6.2					
I _D (A) ^a	40					
Configuration	Single					

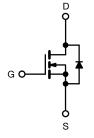
FEATURES

- TrenchFET® Gen IV power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- High power density DC/DC
- Synchronous rectification
- Power conversion
- · Load switch



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SiRA88BDP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	30	V	
Gate-source voltage		V _{GS}	+20, -16	¬	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		40		
	T _C = 70 °C		32		
	T _A = 25 °C	I _D	19 b, c		
	T _A = 70 °C		15 ^{b, c}	^	
Pulsed drain current (t = 100 μs)		I _{DM}	90	A	
Continuous source-drain diode current	T _C = 25 °C		16		
	T _A = 25 °C	I _S	3.4 b, c		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	10		
Single pulse avalanche energy	L = U.1 MH	E _{AS}	5	mJ	
	T _C = 25 °C		17		
Maximum power dissipation	T _C = 70 °C		11	14/	
	T _A = 25 °C	P _D	3.8 b, c	– w	
	T _A = 70 °C		2.4 b, c		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	80	
Soldering recommendations (peak temperature	e) ^{d, e}	J	260	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SMYBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	R _{thJA}	25	33	°C/W
Maximum junction-to-case (drain)	Steady state	R_{thJC}	5.5	7.2	C/ VV

Notes

- a. Based on T_C = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 70 °C/W



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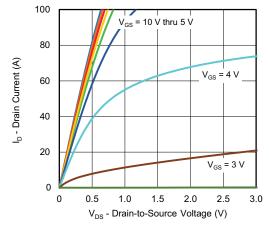
SPECIFICATIONS (T _J = 25 °C, t		,				
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			1	1	1	1
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	,
Drain-source breakdown voltage (c) (transient)	V _{DSt}	$V_{GS} = 0 \text{ V}, I_{D(aval)} = 20 \text{ A}, \\ t_{transcient} \leq 50 \text{ ns}$	36	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA	-	17	-	mV/°C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.4	-	mv/ C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2	-	2.4	V
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = +20, -16 V	-	-	± 100	nA
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α
	_ ` ′	V _{GS} = 10 V, I _D = 10 A	0. 00		0.00683	_
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 8 A	-	0.00830	0.01050	Ω
Forward transconductance a	9 _{fs}	V _{DS} = 10 V, I _D = 20 A	-	42	-	S
Dynamic ^b	310	20 7 7 2	<u> </u>		<u> </u>	l
Input capacitance	C _{iss}		T -	680	_	
Output capacitance	Coss		-	266	_	pF
Reverse transfer capacitance	C _{rss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	54	_	μ
C _{rss} /C _{iss} ratio	Orss		_	0.08	0.16	
Cles, Cles rand	+	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A	_	12.2	19	
Total gate charge	Q_g	VDS = 10 V, VGS = 10 V, ID = 10 A	_	6.2	9.5	
Gate-source charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	_	2.3	-	nC
Gate-drain charge	Q _{gs} Q _{gd}	VDS = 10 V, VGS = 4.0 V, ID = 10 A	_	2.3	_	110
Output charge	Q _{ga} Q _{oss}	V _{DS} = 15 V, V _{GS} = 0 V		7		
Gate resistance	R _g	f = 1 MHz	0.3	1.5	3	Ω
Turn-on delay time	1	1 – 1 1011 12	0.0	8	15	52
Rise time	t _{d(on)}	V 45V B 450		5	10	
Turn-off delay time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω $I_D \cong$ 10 A, V_{GEN} = 10 V, R_q = 1 Ω	_	15	30	
Fall time	t _{d(off)}	10 = 1071, VGEN = 10 V, Ng = 122		5	10	=
	t _f		-	12	25	ns
Turn-on delay time	t _{d(on)}		=			
Rise time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω $I_D \cong$ 10 A, V_{GEN} = 4.5 V, R_α = 1 Ω	-	55	110	
Turn-off delay time	t _{d(off)}	ID = 10 A, VGEN - 4.5 V, Hg - 132	-	15	30	
Fall time	t _f		-	12	25	
Drain-Source Body Diode Characteristi		T 05.00	1		1.0	I
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	16	Α
Pulse diode forward current ^a	I _{SM}		-	-	90	
Body diode voltage	V _{SD}	I _S = 5 A	-	0.8	1.1	V
Body diode reverse recovery time	t _{rr}		-	15	30	ns
Body diode reverse recovery charge	Q _{rr}	$I_F = 5 \text{ A, di/dt} = 100 \text{ A/µs,}$	-	5	10	nC
Reverse recovery fall time	t _a	T _J = 25 °C	-	7	-	ns
Reverse recovery rise time	t _b	t _b		8	-	'''

Notes

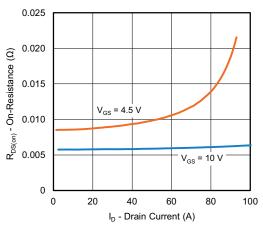
- a. Pulse test: pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Based on characterization, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

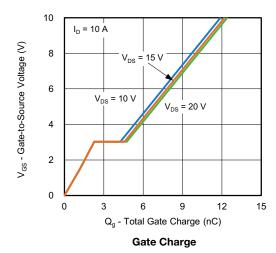


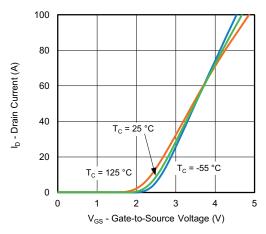


Output Characteristics

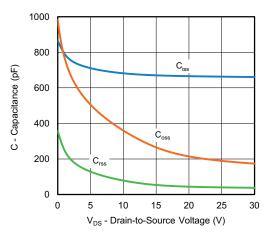


On-Resistance vs. Drain Current

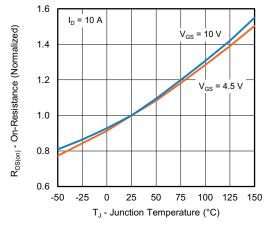




Transfer Characteristics

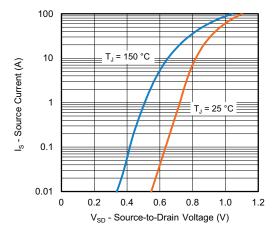


Capacitance

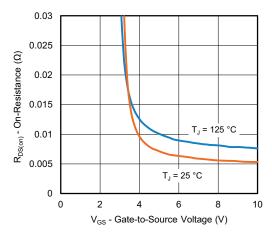


On-Resistance vs. Junction Temperature

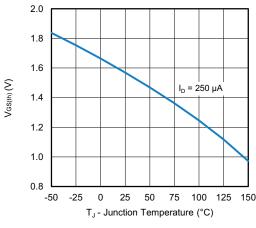




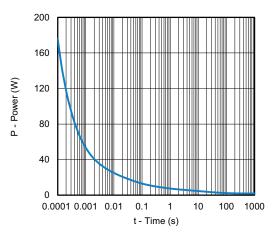
Source-Drain Diode Forward Voltage



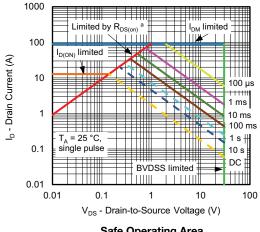
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

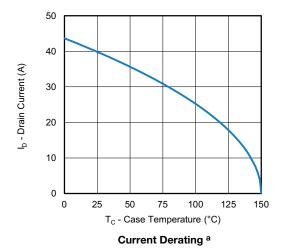


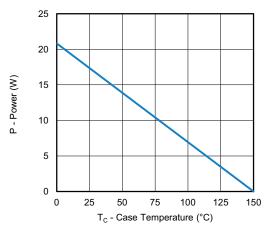
Safe Operating Area

Note

a. V_{GS} > minimum VGS at which R_{DS(on)} is specified





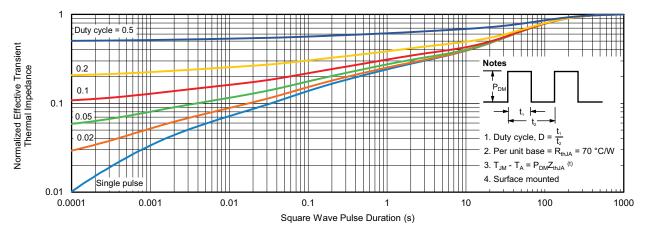


Power, Junction-to-Case

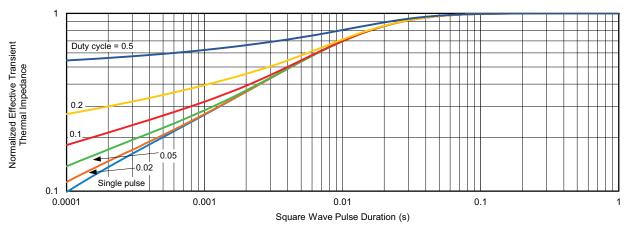
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient

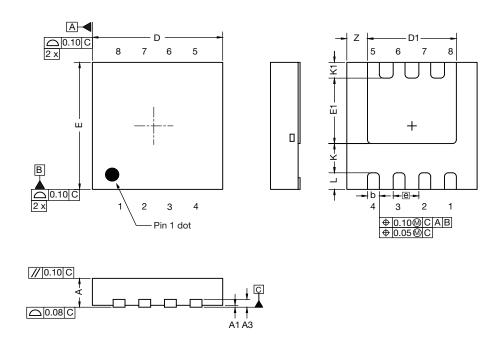


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77158.



Case Outline for PowerPAK® 1212-SWLH



DIM.	MILLIMETERS			INCHES			
DINI.	MIN.	NOM.	MAX.	MIN.	MIN. NOM.		
Α	0.82	0.90	0.98	0.032	0.035	0.038	
A1	0.00	-	0.05	0.000	-	0.002	
A3	0.20 ref.				0.008 ref.		
b	0.25	0.30	0.35	0.010	0.012	0.014	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.15	2.25	2.35	0.085	0.089	0.093	
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	1.60	1.70	1.80	0.063	0.067	0.071	
е		0.65 bsc.			0.026 bsc.		
K	0.76 ref.			0.030 ref.			
K1	0.41 ref.		0.41 ref. 0.016 ref.				
L	0.33	0.43	0.53	0.013	0.017	0.021	
Z	0.525 ref.			0.021 ref.			

ECN: C20-0863-Rev. B, 20-Jul-2020

DWG: 6062



RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



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